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15W, 12V RF Power LDMOS FETs

Description

The ITSN20015P2 is a common source N-channel, enhancement-mode lateral field-effect RF power transistor. It is designed for high gain, broadband commercial and industrial applications, with frequencies up to 2 GHz.

• Typical Performance (On Innogration fixture with device soldered):

 V_{DD} = 12 Volts, I_{DQ} = 300 mA, CW.

Frequency	Cn (dP)	P_1dB	ηD	P_3dB	ηD
(MHz)	Gp (dB)	(W)	(%)	(W)	(%)
870	16.4	18	56	22	60

• Typical Performance (On Innogration fixture with device soldered):

 V_{DD} = 12 Volts, I_{DQ} = 350 mA, CW.

Frequency	Gp (dB)	P_1dB	η _D	P_3dB	η _D
(MHz)		(W)	(%)	(W)	(%)
2000	10.2	14.9	48.7	18.8	52.8

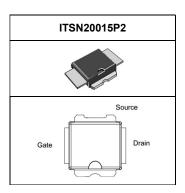


Figure 1. Pin Connection

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Designed for broadband operation
- Excellent ruggedness
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- · Excellent thermal stability, low HCI drift
- · Pb-free, RoHS-compliant

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	$V_{(BR)DSS}$	+40	Vdc
GateSource Voltage	$V_{\sf GS}$	-0.5 to +10	Vdc
Drain Current	I_D	7	А
Power Dissipation(@ T _C = 70 °C)	P _{DISS}	78	W
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	T٦	+165	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Junction-Case Thermal Resistance	R_{thJC}	1.2	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class		
Human Body Model (per JESD22A114)	Class 2		



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Table 4. Electrical Characteristics (TA = 25°C unless otherwise noted)

DC Characteristics

Characteristic and Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Voltage			40		V
V _{GS} =0, I _{DS} =10mA	$V_{(BR)DSS}$		40		V
Zero Gate Voltage Drain Leakage Current				1	Δ.
$(V_{DS} = 25V, V_{GS} = 0 V)$	I _{DSS}			l I	μΑ
Gate-Source Leakage Current				1	
$(V_{GS} = 5 \text{ V}, V_{DS} = 0 \text{ V})$	I _{GSS}			I	μΑ
Gate Quiescent Voltage	V		4.2		V
$(V_{DS} = 10V, I_D = 350 \text{ mA})$	$V_{GS(Q)}$		4.2		V
Drain-Source Voltage (On state)	\ \/			0.32	V
$(V_{GS} = 10V, I_D = 1 A)$	$V_{DS(ON)}$			0.32	V
Common Source Input Capacitance	0		57		,r
(V _{GS} = 0V, V _{DS} =12.5 V, f = 1 MHz)	C _{ISS}		57		pF
Common Source Output Capacitance			41		nE
(V _{GS} = 0V, V _{DS} =12.5 V, f = 1 MHz)	C _{oss}		41		pF
Common Source Feedback Capacitance	0		1.6		nE
(V _{GS} = 0V, V _{DS} =12.5 V, f = 1 MHz)	C _{RSS}		1.0		pF

Functional Tests (In Innogration Test Fixture, 50 ohm system): V_{DD} = 12 Vdc, I_{DQ} = 350 mA, f =2000 MHz, CW

Characteristic	Symbol	Min	Тур	Max	Unit
Power Gain@ P _{OUT} =15W	Gp	8	10		dB
Drain Efficiency@P_3dB	η _D	43	50		%
3dB Compression Point	P_3dB		18		dBm
Load Mismatch, P _{OUT} =15W, All Phase angles	Load Mismatch	20:1			VSWR



TYPICAL CHARACTERISTICS

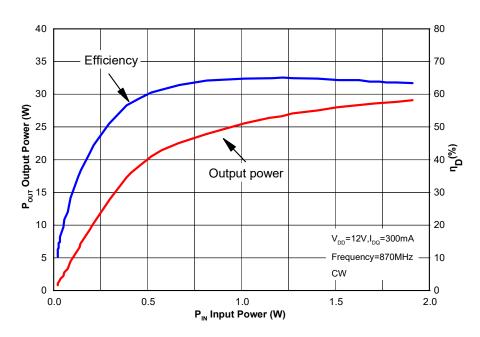


Figure 2. Output power and drain efficiency as function of input power (870MHz)

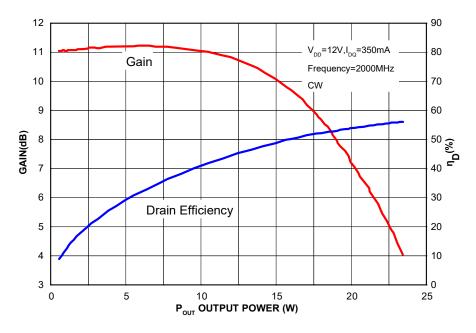
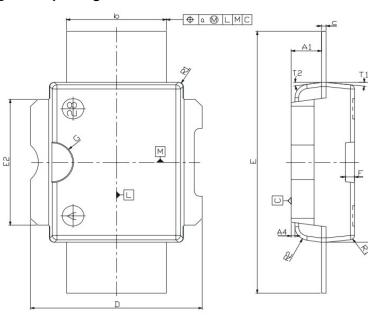


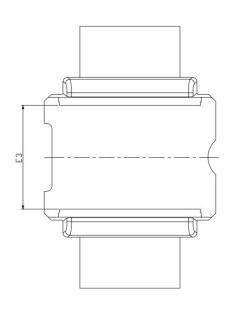
Figure 3. Power gain and drain efficiency as function of output power (2000MHz)

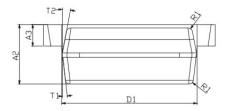


Package Outline

Straight lead package dimensions







CRITICAL DIMENSIONS:

- Overall width (L)

UNIT	A 1	A2	А3	A 4	а	b	С	D	D1	E	E1	E2	E3	F	G
	1.72	3.6	1.4	0.25	0.0	5.65	0.32	9.6	7.6	15.65	9.5	7.5	6.3	0.5	1.0
mm	1.62	3.4	1.2	0.15	0.2	5.4	0.23	9.4	7.4	15.15	9.3	7.3	5.9	0.5	1.2
inahaa	0.068	0.142	0.054	0.009	0.007	0.221	0.012	0.377	0.298	0.615	0.375	0.294	0.247	0.010	0.047
inches	0.064	0.134	0.046	0.005		0.212	0.008	0.370	0.290	0.595	0.365	0.286	0.231	0.019	0.047

	0.064	0.134	0.046	0.005
UNIT	R1	R2	T1	T2
mm	0.25	0.8	6deg	10deg
inches	0.01	0.031	6deg	10deg

Note: Resin protrusions not included (Max. value: 0.15 mm per side)

OUTLINE		REFEI	RENCE	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
PKG-P2-B						23/01/2017

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Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2017/01/23	Rev 1.0	Preliminary Datasheet
2017/02/27	Rev 2.0	Product Datasheet

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